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MICROMECHANICAL SWITCH

Background Information

The present invention is directed to a micromechanical switch according to the definition of the species in the main claim.
5 Micromechanical switches in which a mass is held elastically by a spring element are known in general. During the action of a force such as an acceleration force, for example, the mass is moved and thus the spring element is displaced.

10 Advantages of the Invention

The micromechanical switch according to the present invention having the features of the main claim has the advantage over the related art that the micromechanical switch is implemented
15 from simple basic elements of surface micromechanics which are well known in manufacturing processes. The micromechanical switch according to the present invention also has the advantage over known switches that it achieves miniaturization and brings about suppression of switch bounce. Because of its
20 compact size, considerable cost savings are possible. Another factor that must be considered an advantage is that the micromechanical switch according to the present invention results in savings on evaluation electronics compared with an expanded acceleration sensor system. Furthermore, the
25 micromechanical switch according to the present invention may be operated advantageously without a power supply so that it actually functions only as a switching element.

Advantageous refinements of and improvements on the micromechanical switch specified in the main claim are possible as a result of the measures listed in the subclaims.

5 Particularly advantageous is the fact that the at least one contact element is movable and is connected to a second spring element. This effectively reduces switch bounce because the second spring element brings about a certain contact pressure of the contact element against the mass.

10 Another advantage is that the first spring element and/or the second spring element include U-spring elements. This makes it possible to manufacture the spring elements easily at low cost.

15 Another advantage is that the spring constant of the second spring element is significantly lower than the spring constant of the first spring element. Because of this, the movement of the mass is not substantially hindered or changed by the
20 movement of the mass as it simultaneously contacts the contact element.

Another advantage is that a third spring element is provided which has a stabilizing effect on the movement of the mass.
25 This makes it possible to control the movement of the mass, which is advantageous.

Another advantage is that the spring constant of the third spring element is significantly lower than the spring constant
30 of the first spring element. Because of this, it is possible that the movement of the mass is not substantially changed by the third spring element, and the movement of the mass is determined essentially by the second spring element.

35 Another advantage is that a stop is provided that prevents displacement of the first spring element beyond a specified

maximum degree of displacement of the first spring element.
This prevents the micromechanical switch from being destroyed
in the event of an excessively great acceleration of the mass.

5 Drawing

One exemplary embodiment of the present invention is shown in
the drawing and explained in greater detail in the following
description.

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Figure 1 shows a top view of a micromechanical switch
according to the present invention, and

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Figure 2 shows a sectional view of the micromechanical switch
according to the present invention along section
line AA of Figure 1.

Detailed Description of the Exemplary Embodiment

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Figure 1 shows the micromechanical switch according to the
present invention. The micromechanical switch includes a
movable mass 1, which is provided, in particular, in the form
of a seismic mass 1. The micromechanical switch, which is also
referred to in the following as an acceleration switch, also
25 includes a spring element 2, which is referred to in the
following as first spring element 2. Mass 1 is connected to
first spring element 2. Moreover, mass 1 is movable, first
spring element 2 being displaced when there is a movement of
mass 1. As a result of the displacement of first spring
30 element 2, a restoring force is exerted on mass 1 by first
spring element 2. According to the present invention, mass 1
is intended to be movable only in a linear direction of
movement, for example. This direction of movement is provided
in Figure 1 along section line AA. However, the present
35 invention may also provide that mass 1 be movable in a
plurality of directions of movement. In the exemplary

embodiment shown in Figure 1, a third spring element 4 that stabilizes the movement of mass 1 is also provided. The present invention provides, in particular, that first spring element 2 is on one side of mass 1 along the direction of movement of mass 1 and that third spring element 4 is opposite first spring element 2 along the direction of movement of mass 1. First spring element 2 and third spring element 4 include, in particular, U-spring elements, which are manufacturable using standard micromechanical methods.

In addition, the micromechanical switch includes at least one contact element 3 which, according to the present invention, is connected to a second spring element 30. According to the present invention contact element 3 is a contact mass, in particular, and in an advantageous embodiment is connected as one piece to second spring element 30. The system of the micromechanical switch according to the present invention is such that mass 1 may be moved an initial portion of the distance along its direction of movement while first spring element 2 is displaced to a certain specified degree. With this specified degree of displacement of first spring element 2, mass 1 touches contact element 3, i.e., the contact mass. The present invention then provides that mass 1 and first spring element 2 are designed such that a movement of mass 1 beyond the specified degree of displacement of first spring element 2 is also possible. In this case, therefore, first spring element 1 is displaced even further than the specified degree of displacement, and the contact between mass 1 and contact element 3 remains during this portion of movement. In particular, the present invention provides for connecting contact element 3 to a second spring element 30 so that during the movement of mass 1 in contact with contact element 3, second spring element 30 is also displaced, in addition to the displacement of first spring element 2 beyond the specified degree of its displacement, as a result of which contact element 3, in particular, is pressed against mass 1.

The present invention also provides that the micromechanical switch has stops 7 which prevent mass 1 from executing an excessively large maximum movement in the direction of movement. Stop 7 therefore prevents first spring element 2 from being displaced beyond a specified maximum degree of displacement. The present invention provides that the specified maximum degree of displacement of first spring element 2 is greater than the specified degree of displacement of first spring element 2 at which the first contact making between contact element 3 and mass 1 occurs.

According to the present invention, the micromechanical switch also has, for example, a bonding frame 8 and a first bonding pad 5, i.e., a first terminal surface 5, as well as a first conductor path 6 for contacting first bonding pad 5 to the suspension of contact element 3. In addition, the micromechanical switch according to the present invention also has a second bonding pad 5a and also a conductor path 6a which is used for contacting second bonding pad 5a to the suspensions of first spring element 2. Moreover, the micromechanical switch also has a third bonding pad 5b and a third conductor path 6b which is used for contacting third bonding pad 5b with the suspension of an additional contact element 3b. Additional contact element 3b and its contacting devices (third bonding pad 5b and third conductor path 6b) are optional. What is essential for the operation of the micromechanical switch according to the present invention as a switch is that, via at least two bonding pads 5, 5a, and 5b and corresponding conductor paths 6, 6a, and 6b, at least two contacts are available which are in low-resistance contact with one another electrically during a corresponding movement of mass 1 such that first spring element 2 is displaced beyond the specified degree of displacement. For this purpose, the present invention may provide either that contact making between contact element 3, mass 1 and first spring element 2

and its suspension is effected toward second bonding pad 5a or that contact making is effected from contact element 3 to further contact element 3b as well as to third conductor path 6b and third bonding pad 5b via mass 1 or even that two switches are implemented at the same time, both first contact element 3 and additional contact element 3b being provided and seismic mass 1 being electrically connected via second bonding pad 5a and second conductor path 6a.

Through variation of the width of the U-springs of first spring element 2, second spring element 30 and third spring element 4 and also of their webs between the U-springs, these springs or spring elements 2, 30, and 4 may be adjusted to requirements as linear or non-linear springs.

If an acceleration occurs in the detection direction, mass 1 is accelerated toward first spring element 2. Stabilizing spring 4 or also third spring element 4 is operated in this case in the exemplary embodiment shown in Figure 1 and should be selected so that it does not significantly hinder the movement of mass 1. This is implemented according to the present invention in that the spring constant of third spring element 4 is significantly lower than the spring constant of first spring element 2. Beginning at a defined position of mass 1, mass 1 comes in contact with contact element 3 and contact element 3b so that the switch is closed, i.e., that contact is made between the electrical terminals of contact element 3, 3b and mass 1, i.e., between the electric terminals of contact element 3 and additional contact element 3b and, optionally and in addition, mass 1 as well. A specified degree of displacement of first spring element 2 where the mass contacts at least one contact element 3 corresponds to this defined position of mass 1. Furthermore, a defined action of force on mass 1 corresponds to this specified degree of displacement of first spring element 2, an action of force which is caused, for example, by a defined acceleration of the

entire micromechanical switch such that mass 1 is displaced toward contact element 3 up to the specified degree of displacement of first spring element 2. In the event of a greater displacement or a greater acceleration toward mass 1, contact elements 3, 3b remain connected to mass 1. Second spring element 30 then presses contact element 3 against mass 1. In this way, bouncing of the switch is effectively prevented. Second spring element 30 of contact element 3 should retard the movement of mass 1 only insignificantly, i.e., the switch or the mass, in spite of the contact of mass 1 with contact element 3, continues to move against the restoring force of first spring element 2. According to the present invention, this is ensured in particular by the fact that the spring constant of second spring element 30 is significantly smaller than the spring constant of first spring element 2. The shape of the force curve, however, does not become linear because of the contact of mass 1 with contact element 3. Mass 1 remains in motion as long as a sufficient acceleration is applied to the system of the micromechanical switch or mass 1 strikes stop 7 when there is an excessively large acceleration. Second spring element 30 of contact element 3 in this case serves, first, as bounce protection and, second, it is used for the purpose of prolonging the switching time of the acceleration switch since when there is a decreasing external acceleration and a reverse movement of mass 1 toward smaller displacements of first spring element 2, the contact remains closed until second spring element 30 of contact element 3 is fully relaxed. This results in the advantage that more reliable detection by the acceleration switch is possible due, in particular, to the longer switching time. This behavior of the micromechanical switch according to the present invention and also the movement of the mass in spite of a closed circuit, i.e., the movement of mass 1 when there is displacement of first spring element 2 greater than the specified degree of displacement, may be interpreted as a "moving switch."

Figure 2 shows a sectional view of the micromechanical switch according to the present invention taken along section line AA of Figure 1. The view in Figure 1 is slightly enlarged and is somewhat distorted compared with the view in Figure 1.

5 Figure 2, like Figure 1, shows mass 1 and first spring element 2. Third spring element 4 is shown in Figure 2 on the side of first spring element 2 opposite mass 1. Figure 2 also shows suspension 2a of first spring element 2, the suspension being electrically connected to second bonding pad 5a by
10 second conductor path 6a. Also visible in Figure 2 is frame 8 of the micromechanical switch. The entire micromechanical switch is provided on a substrate 10, according to the present invention, and the moving parts of the micromechanical switch, i.e., in particular mass 1 and spring elements 2, 30, 3, 4 are
15 covered by a cover 9. Cover 9 is not shown in Figure 1.

According to the present invention, substrate 10 is provided, in particular, in the form of a semiconductor substrate such as a silicon substrate, for example. The moving elements in the operating layer of the micromechanical switch designated
20 in Figure 2 by reference numeral 11 are likewise provided according to the present invention in semiconductor material, in particular, such as in silicon, for example. According to the present invention, however, other materials may also be provided, in particular ... [Please insert other alternatives at
25 this point]. Of course it is essential, according to the present invention, to ensure good conductivity of the material of mass 1 and first spring element 2 or second spring element 30 or in general of all elements that are used to conduct current during contact making of the switch.